

BCW70

Rev.F Apr.-2017

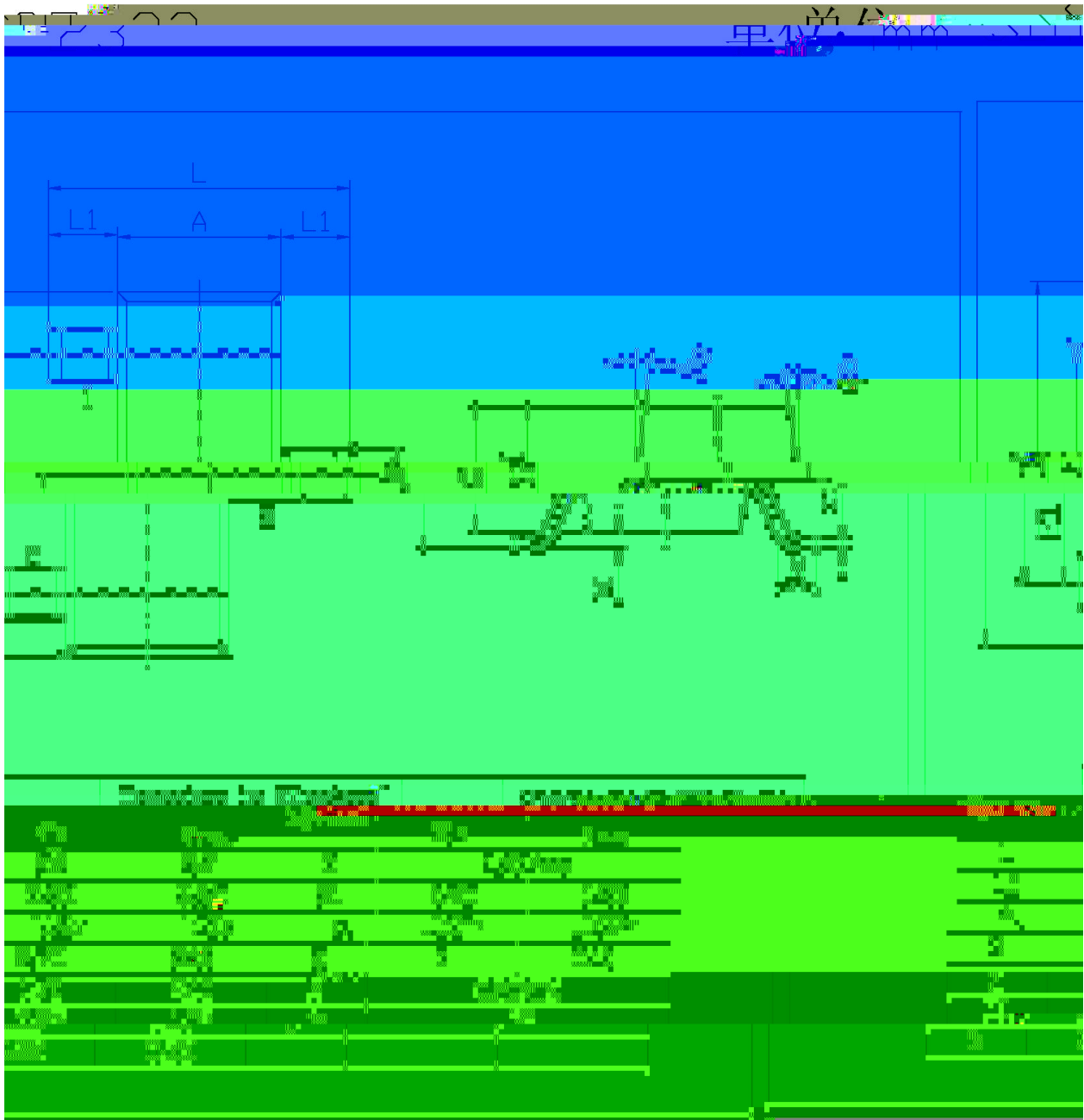
VRW-56

SQS

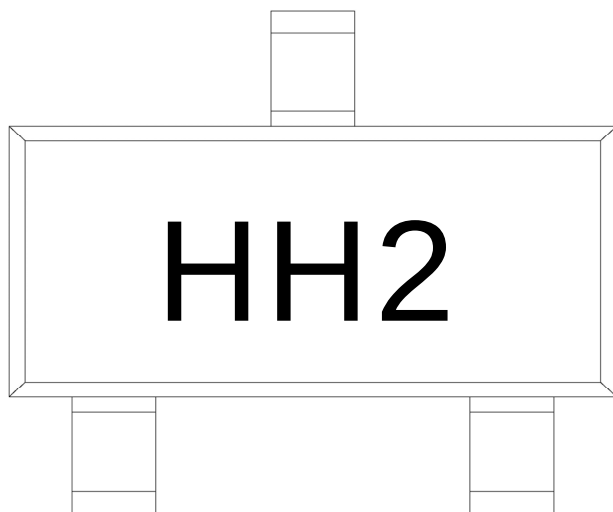
Parameter	N Symbol	Rating	H Unit
Collector to Base Voltage	V_{CBO}	-50	V
Collector to Emitter Voltage	V_{CEO}	-45	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current(DC)	I_C	-100	mA
Peak Collector Current	I_{CM}	-200	mA
Peak Base Current	I_{BM}	-200	mA
Collector Power Dissipation	P_C	250	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	N Symbol	Test Conditions	Min	Typ	Max	H Unit
Collector to Base Breakdown Voltage	V_{CBO}	$I_C = -100\mu A$ $I_E = 0$	-50			V
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C = -500\mu A$ $I_B = 0$	-45			V
Emitter to Base Breakdown Voltage	V_{EBO}	$I_E = -100\mu A$ $I_C = 0$	-5.0			V
Collector Cut-Off Current	I_{CBO}	$V_{CB} = -20 V$ $I_E = 0$			-0.1	μA
Emitter Base Cut-Off Current	I_{EBO}	$V_{EB} = -5.0V$ $I_C = 0$			-0.1	μA
	$h_{FE(1)}$	$V_{CE} = -5.0V$ $I_C = -2.0mA$	215		500	

/ Package Dimensions



/ Marking Instructions



H H

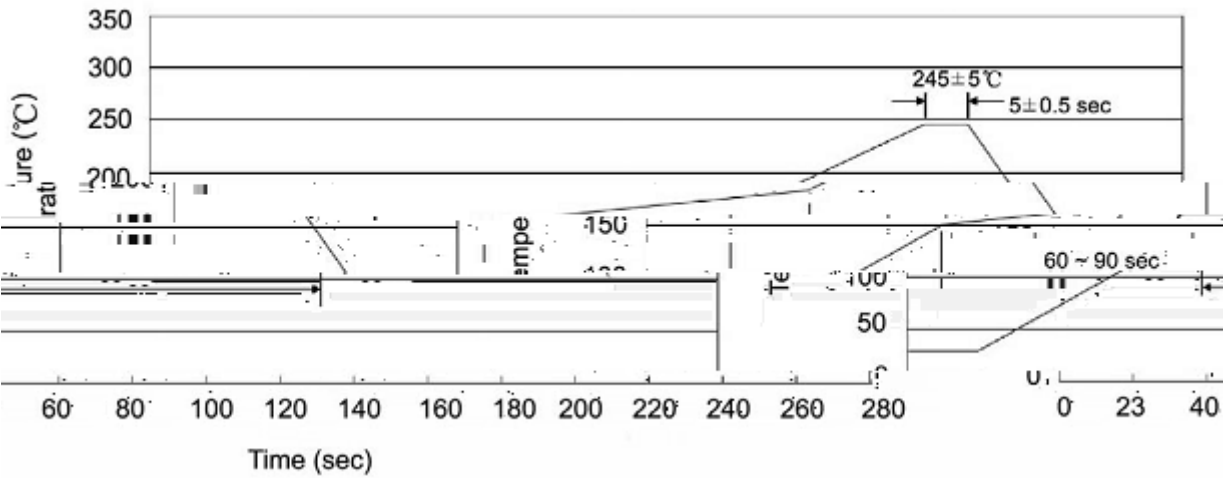
H2 N

Note:

H: Company Code

H2: Product Type Code

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- 1

25 150

60 90sec;

25 150

60 90sec;
- 2

245±5

5±0.5sec;

245±5

5±0.5sec;
- 3

2 10 /sec.

2~10 /sec.

2 10 /sec.

2~10 /sec.

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices